料號

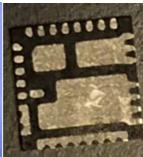
101FD-602155-00R

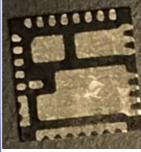
品名規格

DR MOS NCP302155MNTWG ON SMD PQFN-33 5*5 60A

零件樣品圖:







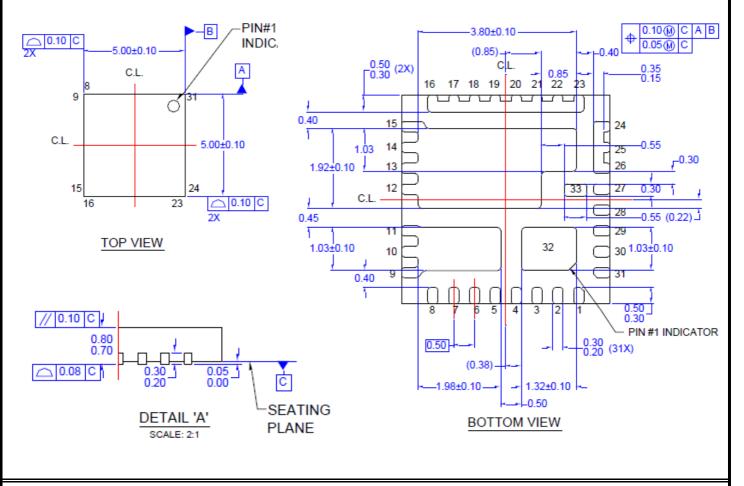
外觀文字面檢驗重點:

請指出何者可變動CHANGEABLE(藍色),何者不可變動 UNCHANGEABLE(紅色),並附加說明代表意義

- Logo(不可變) 1. or
- 2. NCP302155: device mark(不可變)
- 3. D or A: Assembly Location(不可變)
- 4. CR: Wafer Lot(可變) 1835: Data Code(可變)
- 5. PIN1點(不可變)

新封裝廠A料件,12/19驗證ok,加入允收規範

機構尺寸工程圖:



IQC電氣、機構檢驗重點:

- 1. 量測各部尺寸須與規格值相符.
- 2. 檢視產品外觀,表面無異物,且不得有任何破損及變形.
- 3. 電氣特性檢驗:

| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|----------------------|-------------------|----------------------------|-----|-----|-----|------|
| VCC SUPPLY CURRENT | • | | • | | • | • |
| Operating | | DISB# = 5 V, PWM = 400 kHz | - | 1 | 2 | mA |
| No switching | | DISB# = 5 V, PWM = 0 V | - | - | 2 | mA |
| Disabled | | DISB# = 0 V SMOD# = VCC | - | 0.4 | 1 | μА |
| | | DISB# = 0 V SMOD# = GND | | 6 | 13 | μА |
| UVLO Start Threshold | V _{UVLO} | VCC rising | 2.9 | - | 3.3 | V |
| UVLO Hysteresis | | | 150 | - | - | m∨ |

4. 包裝方式如下,詳細請查閱data sheet.



Embossed Tape and Reel Ordering Information

| | • | • | | | | | | |
|---------------------------------------|--|--|------------|---------|--|----------------------------------|-------|-------|
| Package V | Tape Width mm | Pitch mm (Dimension P ₁) (inch) | Reel Size | | Devices Per Reel and Min | Tape and Reel Suffix | Fig | Page |
| | | | (mm) | (in) | Order Quantity | Tape and Neel Sumx | No | No |
| 6-Bump (1.489x0.989) | 8 | 4.0 ± 0.1 (0.158 ± 0.004) | 178 | 7 | 3,000 | T1 - TMOS | 7 | 14 |
| 9-Bump (1.489x1.489) | 8 | 4.0 ± 0.1 (0.158 ± 0.004) | 178 | 7 | 3,000 | T1 - TMOS | 7 | 14 |
| 10-Bump | 8 | 4.0 ± 0.1 (0.158 ± 0.004) | 178 | 7 | 3,000 | T1 - Discrete | 7 | 14 |
| Axial Leaded | See Axial Leaded package specifications beginning on page 27 | | | | | | | |
| ChipFET | 8 | 4.0 ± 0.1 (0.158 ± 0.004) | 178 | 7 | 3,000 | T1 - TMOS | 11 | 15 |
| D ² PAK 3 Lead | 24 | 16.0 ± 0.1 (0.630 ± 0.004) | 330 | 13 | 800 | R4 Analog T4 - Discrete | 1 | 13 |
| D ² PAK 5 Lead | 24 | 16.0 ± 0.1 (0.630 ± 0.004) | 330 | 13 | 800 | R4 - Analog T4 - Discrete | 1 | 13 |
| D ² PAK 7 Lead | 24 | 16.0 ± 0.1 (0.630 ± 0.004) | 330 | 13 | 750 | R7 - Analog | 1 | 13 |
| DFN/QFN ≤ 1.4x1.4mm | 8 | 2.0 ± 0.1 (0.079 ± 0.004) | 178 | 7 | See Data Sheet | Various | 36-38 | 19,20 |
| DFN/QFN ≤ 3.3x3.3mm | 8 8 | 4.0 ± 0.1 (0.158 ± 0.004) 4.0 ± 0.1 (0.158 ± 0.004) | 178 330 | 7 13 | See Data Sheet See Data Sheet | See Data Sheet See Data Sheet | 36-38 | 19,20 |
| DFN/QFN > 3.3x3.3mm and ≤ 7x7mm | 12 12 | 8.0 ± 0.1 (0.315 ± 0.004) 8.0 ± 0.1 (0.315 ± 0.004) | 178 330 | 7 13 | See Data Sheet See Data Sheet | See Data Sheet See Data Sheet | 36-38 | 19,20 |
| DFN/QFN 7x7mm | 12 12 | 16.0 ± 0.1 (0.630 ± 0.004) 16.0 ± 0.1 (0.630 ± 0.004) | 178 330 | 7 13 | See Data Sheet See Data Sheet | See Data Sheet See Data Sheet | 36-38 | 19,20 |
| | | | | _ | | | | - |

μ-EDX 有害物質檢測:

 μ -EDX 需依照HCSR 有害物質管制規範實施檢測,並參照IQC EDX Test Guide 規範。

| Date: 2018/8/23 | Rev. 00 | 首次發行 |
|------------------|---------|----------------|
| Date: 2018/11/16 | Rev. 01 | 更新外觀文字面檢驗重點 |
| Date: 2019/12/20 | Rev. 02 | 新封裝廠A料件,加入允收規範 |